FAST HIGH VOLTAGE Q-SWITCH DRIVER

General

The Series FQD Q-switch drivers are miniaturized high voltage pulsers for driving Pockels cells in Laser quality switching applications. FQD drivers contain everything necessary for a ready-to-use solution, including a highly reliable Behlke solid-state switch and various passive HV part components. Due to its very small dimensions, the FQD driver can be integrated directly into the laser setup. As a result, the length of the pulse transmission line between Q-switch driver and Pockels cell is reduced to a few inches / cm. The capacitive losses are thereby substantially decreased, keeping the power consumption and, consequently, the thermal emission of the driver very low, especially in cases of higher repetition rates. The standard FQD drivers described here are working in the ON-Mode with positive voltage. Additionally, OFF-Mode types for positive voltage are optionally available (option OFF). OFF and ON-Mode types can be configured for negative high voltage power supplies (option NEG). The internal circuit for the ON-Mode type is shown in Fig. 1 and for the OFF-Mode type in Fig. 2.

Operation

The solid-state switch, SW, is triggered by a positive going TTL pulse at pin 1. A successful triggering is indicated by the yellow LED. The trigger pulse amplitude should be 3 to 6 V and the trigger pulse slew rate should not be less than 100 mV/ns for best jitter results. Apart from jitter behaviour, output pulse rise time or output pulse width can not be influenced by the quality of trigger. The trigger pulse duration is uncritical. Any value between 50 ns and infinity is sufficient. To achieve the lowest possible pulse delay and best long-term stability in respect to jitter, the auxiliary voltage (5.00 VDC) should permanently be applied to pin 3, when the FQD is in operation. After triggering, the switch remains on for about 100 ns. The effective pulse width at the Pockels cell is much longer, because of the time constant R₁ x C₁. The effective output pulse width for standard devices is approx. 200 ns at C_L =10pF and R_L = 20kOhm. The time constant can be adapted to the specific requirements by an optional variation of R_L (option M-RL, possible R₁ values are from 1kOhm to 1GOhm). In case of increased demands regarding the top flatness of pulse, the real on-time of the switch can be optionally extended up to 100 µs (options OT-1µs, OT-10µs or OT-100µs). Please note the increased resistive losses at R₁ in such a case. The output pulse rise time can also be adapted to specific requirement by means of customized values for the damping resistor R_s (option M-RS, useful values are 0 to 100 Ohm). The FQD standard device is configured so that all the requirements of a typical Q-switch application are met. In case of specific requirements please choose from the above options or consult Behlke. The control circuit of the FQD driver contains a protective circuit, which monitors the auxiliary voltage, the maximum repetition rate and the maximum operating temperature. If a disturbance should occur, the FQD driver is turned off and a TTL fault signal is generated at pin 4. The fault condition is also indicated by a red LED.

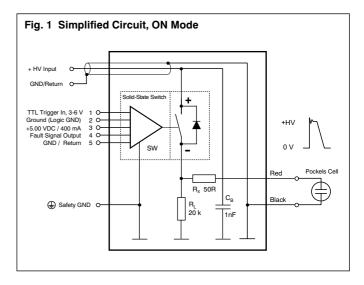
Housing Options

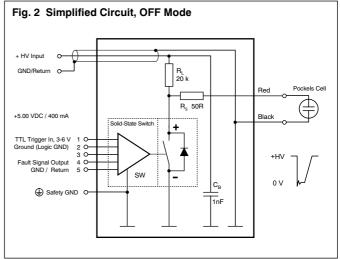
Various housing options are available. Generally, the standard plastic case (25 or 19 mm height) is sufficient for low and medium repetition rates (max. 1000 to 2000 pps). At higher repetition rates, the standard plastic case must be combined with a sufficient cooling option. If a liquid cooling is already available in the laser system, the option DLC (direct liquid cooling) maybe adequate. This option is for non-conductive liquids (e.g. GALDEN) only. The use of conductive liquids requires the option DLC-ISO. Heat can also be removed locally by natural or forced convection. For this purpose, the FQD driver can also be fitted with a ceramic cooling surface (option CCS), with non-isolated cooling fins (CF) or with a grounded cooling flange (GCF) for attachment on heat sinks. Please consult Behlke for further details.

FQD 40-03 4000 VDC / 35 A (pk)
FQD 50-02 5000 VDC / 25 A (pk)
FQD 80-01 8000 VDC / 15 A (pk)



- Compact design Very easy to use
- Reliable no avalanche technique!







TECHNICAL DATA

Specification	Symbol	Condition / Comment			FQD 40-03	FQD 50-02	FQD 80-01	Unit
Maximum Operating Voltage	V _{O(max)}	T _{case} = 25 °C, I _{off} < 100 μADC		4000	5000	8000	VDC	
Lowest Operating Voltage	V _{O(min)}				0		VDC	
Typical Breakdown Voltage	V _{Br}	I _{off} > 1mADC, T _{case} = 70 °C			4200	5250	8400	VDC
Galvanic Isolation	VI	HV side against control side				> 10000		VDC
Maximum Peak Current	I _{P(max)}	Peak current is internally limited			35	25	15	ADC
Output Impedance	Z _{out}	Standard devices, see option M-RS			75	75	75	Ω
Maximum Off-State Current	l _{off}	T _{case} = 25 °C, 0.8 x V ₀ . Lower l _{off} on request.				10		μADC
Typical Turn-On Delay Time	t _{d(on)}	Shorter delay on request				50		ns
Typical HV Pulse Rise Time	tr	- @ 0.8 x V _{O(max)} C _L = 5 pF		2.5	2.6	3.2		
		- Standard output impedance 75 Ω		C _L =10 pF	2.9	3.1	4.4	
				C _L =20 pF	3.7	4.0	5.6	ns
Typical Switch On-Time	ton	Switch on-time only. See also option	Switch on-time only. See also options OT-xxxx			100		ns
Effective HV Pulse Width	t _{p(HV)}	C _L =10 pF, top flatness < 3%. See also option M-RL.				200		ns
Typical HV Pulse Fall Time	tf	10-90%, C _L =10 pF. See also optio	10-90%, C _L =10 pF. See also option M-RL.			1.2		μs
Switch Recovery Time	trc	Driver recovery only. Trigger pulse tp =100 ns				500		ns
Typical Turn-On Jitter	t _{j(on)}	V _{aux} / V _{tr} = 5.00 VDC			100		ps	
Max. Continuous Frequency	f _(max)	Cooling may be required at	Standard dev	vices		50		
, ,	·(max)	higher operating frequency	With Option I	HFS		150		
			Customized	units		up to 500		kHz
Maximum Burst Frequency	f _{b(max)}	Use option HFB for >10 pulses		<u> </u>		2		MHz
Typical Power Dissipation	Pd	@ 0.8 x V _{O(max)}	f= 2 kHz	C _L =10 pF	1.1	1.5	3.1	
		C _L = Pockels cell capacitance		C _L = 5 pF	8.9	12.5	31.2	
		Data valid for cooling option GCF.	f= 20 kHz	C _L =10 pF	10.8	15.4	37.8	
		Standard devices without cooling		C _L =20 pF	12.8	16.3	44.8	
		options have 10% less losses.	f= 100 kHz	C _L =10 pF	54	77	189	Watts
Maximum Continuous Power	P _{d(max)}	Standard devices & Option FC, T _{case} = 25 °C				5		
Dissipation		With Option DLC / ILC, T _{liquid} = 25 °C, 1 liter/min				60-200	(consult Behlke)	
		With Option GCF, T _{flange} = 25 °C				200	(Watts
Operating Temperature Range	То	Extended range on request				-4070		°C
Storage Temperature Range	T _{ST}	Extended range on request				-5090		°C
Typical Coupling Capacitance	Cc	HV side against control side				10		pF
Auxiliary Supply Voltage	Vaux	< 2% stabilty recommended (±5% max.)				5.00		VDC
Typ. Auxiliary Supply Current	I _{aux}	T _{case} = 25 °C, 0.8 x V ₀ @ 0,01 x f _{max}		·		150		
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Trigger Signal Voltage Range	Vtr	3-6 VDC recommended for low jitter			2-10			VDC
Minimum Trigger Pulse Width	t _{ptr(min)}	Switching behaviour cannot be influenced by trigger pulse			50			ns
Fault Signal Output Voltage	φυ()	Indicates over temperature, over fr		eady" = H		4.5		
T duit Oighar Output Voltago		(>100 kHz) and low aux. voltage (< 4.75 V) "Fault" = L		0.8		VDC		
Fault Signal Output Current		Source/sink current, short circuit proof			10		mADC	
LED Indicators		Green LED Yellow LED			"Ready, auxiliary power good"			
					"Switch triggered"			
		Red LED	"Fault condition, switch off"					
Dimensions		Standard case			79.5 x 38 x 19			
		Option DLC			79.5 x 38 x 25			
		Option GCF			95 x 50 x 22			mm ³
Weight		Standard case			110			
- 9		Option DLC Option GCF			150			
					220			g

Ordering Informations

Option OT-100 μ Switch on-time 100 μ s

FQD 40-03	Q-switch driver, on mode, 4000 VDC, 35 Amps.	Option PL-HV	Plug connector for high voltage connection
FQD 50-02	Q-switch driver, on mode, 5000 VDC, 25 Amps.	Option SPT-C	Shielded pigtail for control connection, incl. LEMO plug
FQD 80-01	Q-switch driver, on mode, 8000 VDC, 15 Amps.	Option HFB	High frequency burst
Option OFF	Off mode configuration	Option HFS	High frequency switching
Option NEG	Negative high voltage supply / negative output pulse polarity	Option UL94	Flame retardend casting resin according to UL94-VO
Option M-RL	Modified working resistor (customized HV pulse, $t_{p(HV)}$ & t_f)	Option GCF	Grounded cooling flange (attachment on heatsinks)
Option M-RS	Modified damping resistor (customized HV pulse damping, t _r)	Option DLC	Direct liquid cooling for non-conductive liquids
Option OT-1µ	Switch on-time 1 µs	Option ILC	Indirect liquid cooling for conductive & non-conductive liquids
Option OT-10u	Switch on-time 10 us		

For further options please refer to the product survey "D – Laboratory and OEM pulsers"